

Photocouplers Photorelay

# TLP220GA

### 1. Applications

- Mechanical relay replacements
- Security Systems
- Measuring Instruments
- Factory Automation (FA)
- Amusement Equipment
- Smart Meters
- Electricity Meters

#### 2. General

The TLP220GA photorelay consists of a photo MOSFET optically coupled to an infrared light emitting diode. It is housed in a 4-pin DIP package. It provides an isolation voltage of 5000 Vrms, making it suitable for applications that require reinforced insulation.

#### 3. Features

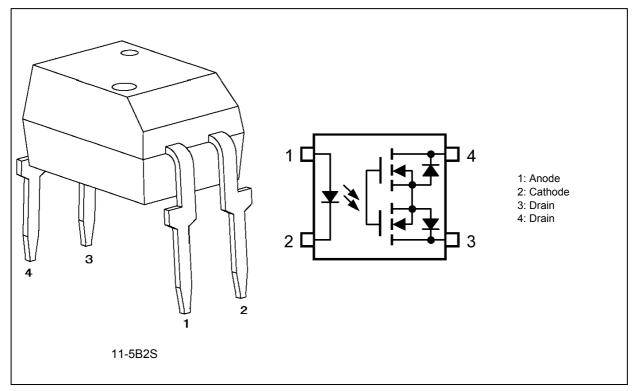
- (1) Normally off (1-Form-A)
- (2) OFF-state output terminal voltage: 400 V (min)
- (3) Trigger LED current: 2 mA (max)
- (4) ON-state current: 120 mA (max)
- (5) ON-state resistance:  $28 \Omega$  (max, t < 1s)
- (6) ON-state resistance:  $35 \Omega$  (max, Continuous)
- (7) Isolation voltage: 5000 Vrms (min)
- (8) Safety standards

UL-approved: UL1577 File No. E67349

cUL-approved: CSA Component Acceptance Service No. 5A, File No. E67349

VDE-under application: Option (D4) EN60747-5-2

### 4. Packaging and Pin Configuration



### 5. Internal Circuit

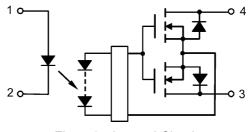


Fig. 5.1 Internal Circuit

### 6. Mechanical Parameters

Characteristics	7.62-mm Pitch TLP220GA	10.16-mm Pitch TLP220GAF	Unit
Creepage distances	7.0 (min)	8.0 (min)	mm
Clearance distances	7.0 (min)	8.0 (min)	
Internal isolation thickness	0.4 (min)	0.4 (min)	

#### 7. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25^{\circ}$ C)

	Characteristics	Symbol	Note	Rating	Unit	
LED	Input forward current		IF		30	mA
	Input forward current derating	$(T_a \ge 25^{\circ}C)$	$\Delta I_F / \Delta T_a$		-0.3	mA/°C
	Input forward current (pulsed)	(100 μs pulse, 100 pps)	I <sub>FP</sub>		1	A
	Input reverse voltage		V <sub>R</sub>		5	V
	Input power dissipation		PD		50	mW
	Junction temperature		Tj		125	°C
Detector	OFF-state output terminal voltage	V <sub>OFF</sub>		400	V	
	ON-state current		I <sub>ON</sub>		120	mA
	ON-state current derating	$(T_a \ge 25^{\circ}C)$	$\Delta I_{ON} / \Delta T_a$		-1.2	mA/°C
	ON-state current (pulsed)	(t = 100 ms, Duty = 1/10)	I <sub>ONP</sub>		360	mA
	Output power dissipation		Po		500	mW
	Junction temperature		Тј		125	°C
Common	Storage temperature		T <sub>stg</sub>		-55 to 125	
	Operating temperature		T <sub>opr</sub>		-40 to 85	
	Lead soldering temperature	(10 s)	T <sub>sol</sub>		260	
	Isolation voltage	AC, 1 min, R.H. ≤ 60%	BVS	(Note 1)	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

### 8. Recommended Operating Conditions (Note)

Characteristics	Symbol	Note	Min	Тур.	Max	Unit
Supply voltage	V <sub>DD</sub>		_	_	320	V
Input forward current	I <sub>F</sub>		3	5	15	mA
ON-state current	I <sub>ON</sub>		_	_	120	
Operating temperature	T <sub>opr</sub>		-20	_	65	°C

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this datasheet should also be considered.

#### 9. Electrical Characteristics (Unless otherwise specified, $T_a = 25^{\circ}C$ )

	Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
LED	Input forward voltage	V <sub>F</sub>		I <sub>F</sub> = 10 mA	1.45	1.63	1.75	V
	Input reverse current	I <sub>R</sub>		V <sub>R</sub> = 5 V	_	_	10	μA
	Input capacitance	Ct		V = 0 V, f = 1 MHz	_	40	—	pF
Detector	OFF-state current	I <sub>OFF</sub>		V <sub>OFF</sub> = 400 V	_	_	1	μA
	Output capacitance	C <sub>OFF</sub>		V = 0 V, f = 1 MHz	_	80	_	pF

### 10. Coupled Electrical Characteristics (Unless otherwise specified, $T_a = 25^{\circ}C$ )

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I <sub>FT</sub>		I <sub>ON</sub> = 120 mA	_	0.3	2	mA
Return LED current	I <sub>FC</sub>		I <sub>OFF</sub> = 10 μA	0.1	_	_	mA
ON-state resistance	R <sub>ON</sub>		I <sub>ON</sub> = 120 mA, I <sub>F</sub> = 5 mA, t < 1 s		17	28	Ω
		(Note 1)	$I_{ON}$ = 120 mA, $I_F$ = 5 mA, Continuous	_	22	35	

Note 1: Thermally saturated state.

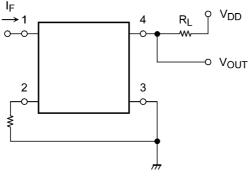
### 11. Isolation Characteristics (Unless otherwise specified, $T_a = 25^{\circ}C$ )

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Total capacitance (input to output)	Cs	(Note 1)	V <sub>S</sub> = 0 V, f = 1 MHz	_	0.8	—	pF
Isolation resistance	R <sub>S</sub>	(Note 1)	$V_S$ = 500 V, R.H. $\leq 60\%$	$1  imes 10^{12}$	10 <sup>14</sup>	_	Ω
Isolation voltage	BVS		AC, 1 min	5000	_	_	Vrms
			AC, 1s in oil	_	10000	—	
			DC, 1 min, in oil	_	10000	_	Vdc

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

### 12. Switching Characteristics (Unless otherwise specified, $T_a = 25^{\circ}C$ )

Characteristics	Symbol	Note	Test Condition	Min	Тур	Max	Unit
Turn-on time	t <sub>ON</sub>		See Fig. 12.1.	—	0.2	1	ms
Turn-off time	t <sub>OFF</sub>		R <sub>L</sub> = 200 Ω, V <sub>DD</sub> = 20 V, I <sub>F</sub> = 5 mA	—	0.2	1	



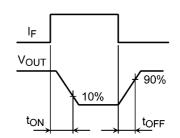
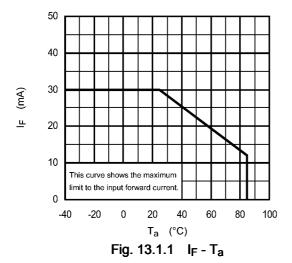
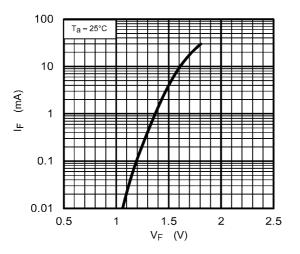


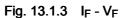
Fig. 12.1 Switching Time Test Circuit

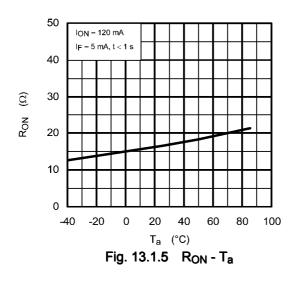
### 13. Characteristics Curves

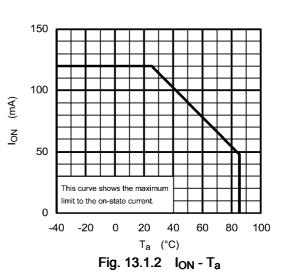
### 13.1. Characteristics Curves (Note)











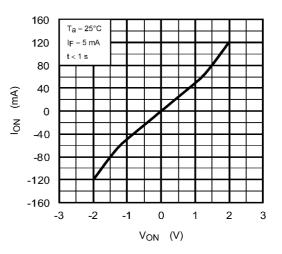
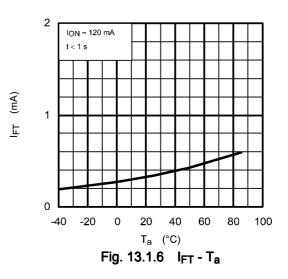


Fig. 13.1.4 I<sub>ON</sub> - V<sub>ON</sub>



20

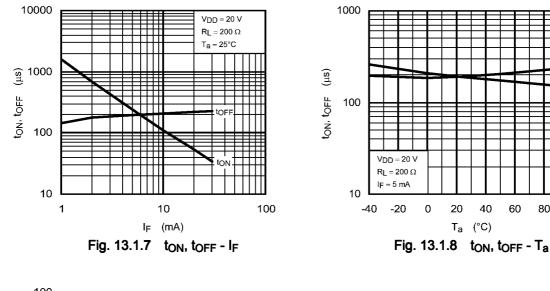
Тa (°C)

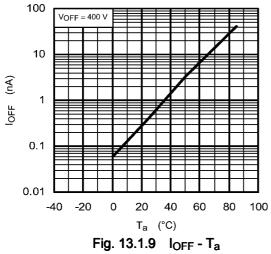
40

60

80

100





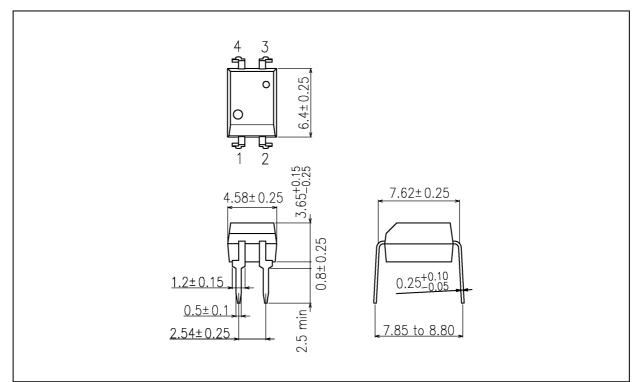
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



### TLP220GA

### Package Dimensions

Unit: mm



Weight: 0.26 g (typ.)

	Package Name(s)
TOSHIBA: 11-5B2S	

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